

UNITED STATES PATENT AND TRADEMARK OFFICE

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BEFORE THE PATENT TRIAL AND APPEAL BOARD

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TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.  
(TSMC) and SAMSUNG ELECTRONICS CO., LTD,  
Petitioner,

v.

DSS TECHNOLOGY MANAGEMENT, INC.,  
Patent Owner.

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Case IPR2014-01030<sup>1</sup>  
Patent 5,652,084

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Before ERICA A. FRANKLIN, JACQUELINE WRIGHT BONILLA, and  
KRISTINA M. KALAN, *Administrative Patent Judges*.

KALAN, *Administrative Patent Judge*.

DECISION  
Motion for *Pro Hac Vice* Admission  
37 C.F.R. § 42.10(c)

On February 6, 2015, Petitioner Taiwan Semiconductor Manufacturing Company, Ltd. (“TSMC”) filed a Motion for *Pro Hac Vice* Admission of Mr. Scott Cunning and an accompanying Affidavit in the above-captioned proceeding. IPR2014-01030, Paper 13, Ex. 1013. Patent Owner did not file an opposition to the Motion within the one-week period permitted for such a filing. *See* IPR2013-

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<sup>1</sup> Case IPR2014-01493 has been joined with this proceeding.

00639, Paper 7, p. 3 (“Parties seeking to oppose a motion for *pro hac vice* admission must file their opposition no later than one week after the filing of the underlying motion.”). After considering Petitioner TSMC’s Motion and accompanying Affidavit, it is

**ORDERED** that Petitioner TSMC’s Motion for *Pro Hac Vice* Admission of Mr. Scott Cunning is *granted*;

**FURTHER ORDERED** that Petitioner TSMC is to continue to have a registered practitioner as lead counsel in the instant proceeding, but Mr. Scott Cunning is authorized to be designated as backup counsel; and

**FURTHER ORDERED** that Mr. Scott Cunning is to comply with the Office Patent Trial Practice Guide and the Board’s Rules of Practice for Trials, as set forth in Title 37, Part 42 of the C.F.R., and is subject to the USPTO’s disciplinary jurisdiction under 37 C.F.R. § 11.19(a) and the USPTO Rules of Professional Conduct as set forth in 37 C.F.R. §§ 11.101 *et seq.*

IPR2014-01030  
Patent 5,652,084

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